

N-Channel 150-V (D-S) MOSFET

PRODUCT SUMMARY

V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A) ^a	Q_g (Typ.)
150	0.126 at $V_{GS} = 10$ V	13	9.5 nC

FEATURES

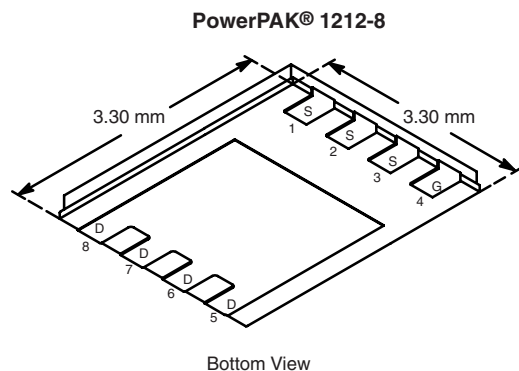
- Halogen-free
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested



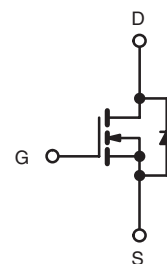
RoHS
COMPLIANT

APPLICATIONS

- Primary Side Switch



Ordering Information: Si7620DN-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ($T_J = 150$ °C)	$T_C = 25$ °C	13	A
	$T_C = 70$ °C	10.7	
	$T_A = 25$ °C	3.6 ^{b, c}	
	$T_A = 70$ °C	2.9 ^{b, c}	
Pulsed Drain Current	I_{DM}	15	
Avalanche Current	I_{AS}	10	
Avalanche Energy	E_{AS}	5	mJ
Continuous Source-Drain Diode Current	$T_C = 25$ °C	13	A
	$T_A = 25$ °C	3.2 ^{b, c}	
Maximum Power Dissipation	$T_C = 25$ °C	5.2	W
	$T_C = 70$ °C	33	
	$T_A = 25$ °C	3.8 ^{b, c}	
	$T_A = 70$ °C	2 ^{b, c}	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 150	°C
Soldering Recommendations (Peak Temperature) ^{d, e}		260	

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{b, f}	$t \leq 10$ s	R_{thJA}	24	33	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	1.9	2.4	

Notes:

- Based on $T_C = 25$ °C.
- Surface Mounted on 1" x 1" FR4 board.
- $t = 10$ s.
- See Solder Profile (<http://www.vishay.com/ppg?73257>). The PowerPAK 1212 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- Maximum under Steady State conditions is 81 °C/W.

SPECIFICATIONS T _J = 25 °C, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	150			V
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = 250 μA		180		mV/°C
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J			- 9		
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	2.5		4.5	V
Gate-Source Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 150 V, V _{GS} = 0 V			1	μA
		V _{DS} = 150 V, V _{GS} = 0 V, T _J = 55 °C			5	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	13			A
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 3.6 A		0.103	0.126	Ω
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 3.6 A		10		S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		600		pF
Output Capacitance	C _{oss}			50		
Reverse Transfer Capacitance	C _{rss}			15		
Total Gate Charge	Q _g	V _{DS} = 75 V, V _{GS} = 10 V, I _D = 3.6 A		9.5	15	nC
Gate-Source Charge	Q _{gs}			3		
Gate-Drain Charge	Q _{gd}			2.5		
Gate Resistance	R _g	f = 1 MHz		1.1	2.2	Ω
Turn-On Delay Time	t _{d(on)}	V _{DD} = 75 V, R _L = 26 Ω I _D ≅ 2.9 A, V _{GEN} = 10 V, R _g = 1 Ω		12	20	ns
Rise Time	t _r			5	10	
Turn-Off Delay Time	t _{d(off)}			15	25	
Fall Time	t _f			5	10	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			13	A
Pulse Diode Forward Current	I _{SM}				15	
Body Diode Voltage	V _{SD}	I _S = 2.9 A, V _{GS} = 0 V		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}	I _F = 2.9 A, dI/dt = 100 A/μs, T _J = 25 °C		50	75	ns
Body Diode Reverse Recovery Charge	Q _{rr}			125	190	nC
Reverse Recovery Fall Time	t _a			37		ns
Reverse Recovery Rise Time	t _b			13		

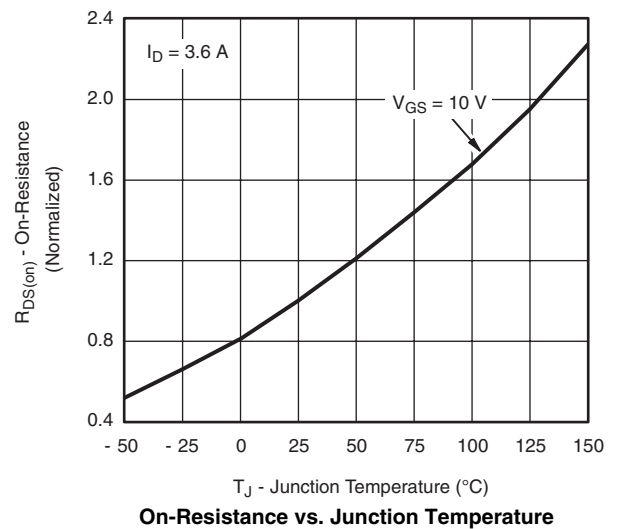
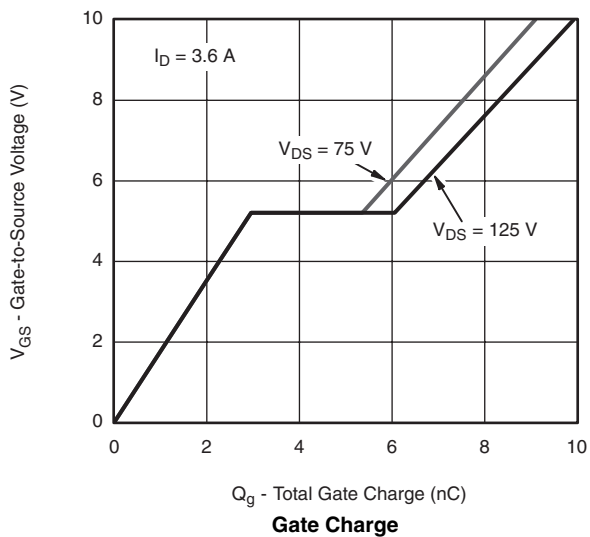
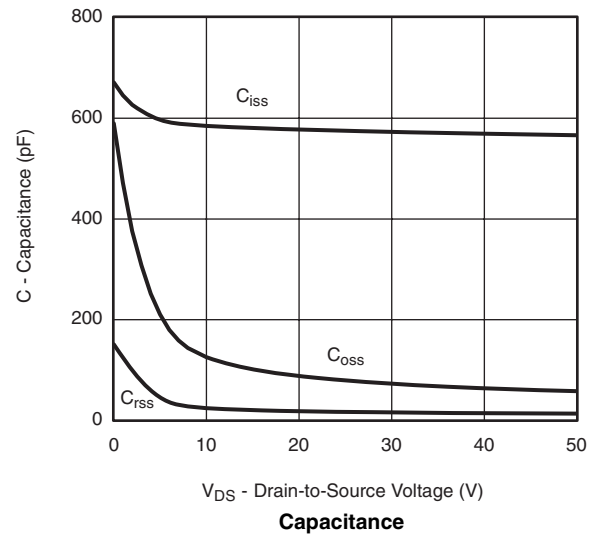
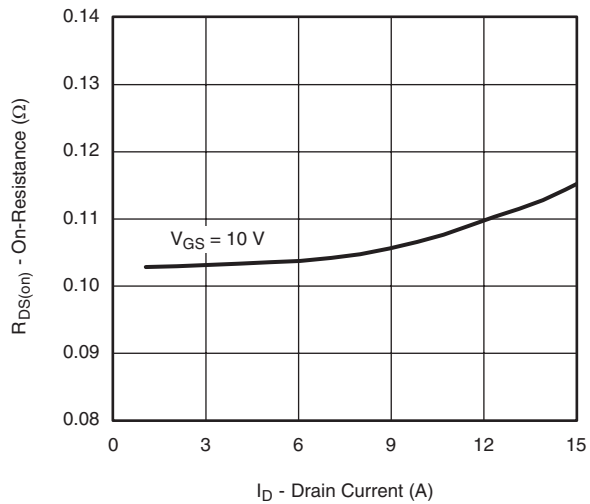
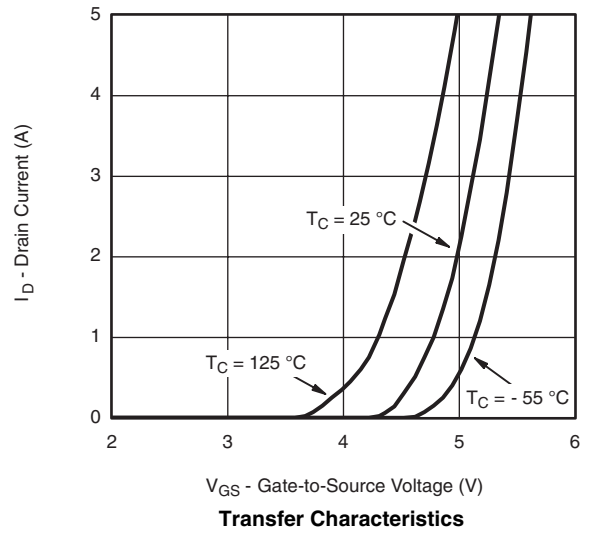
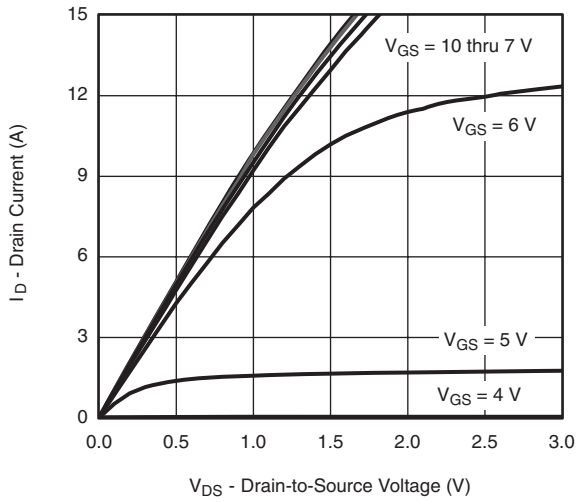
Notes:

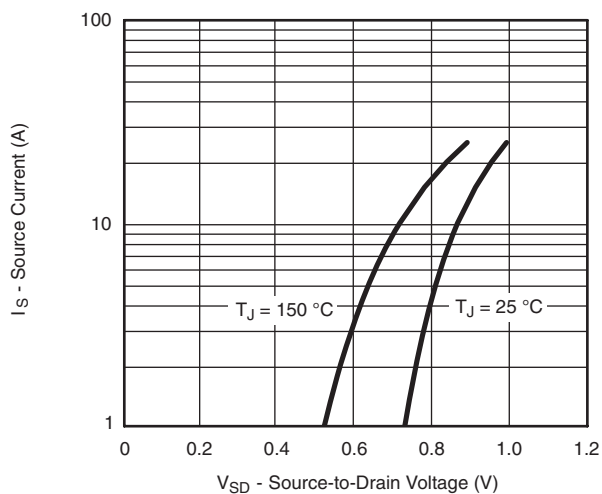
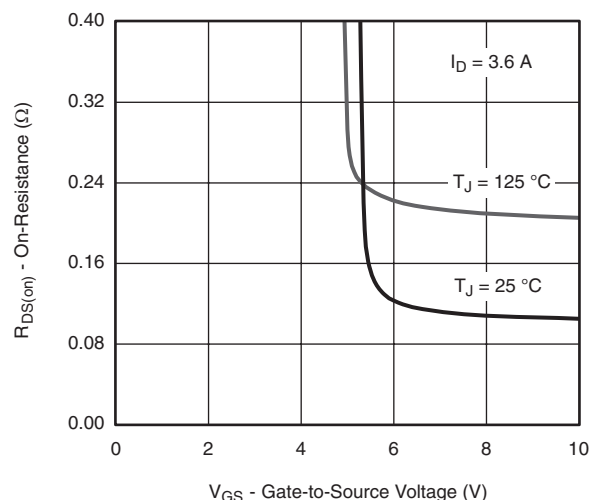
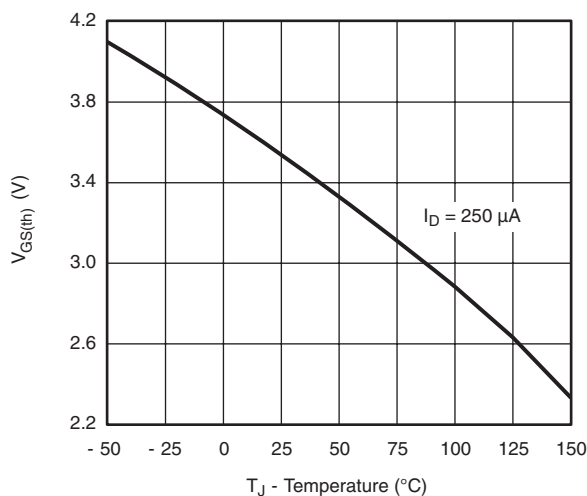
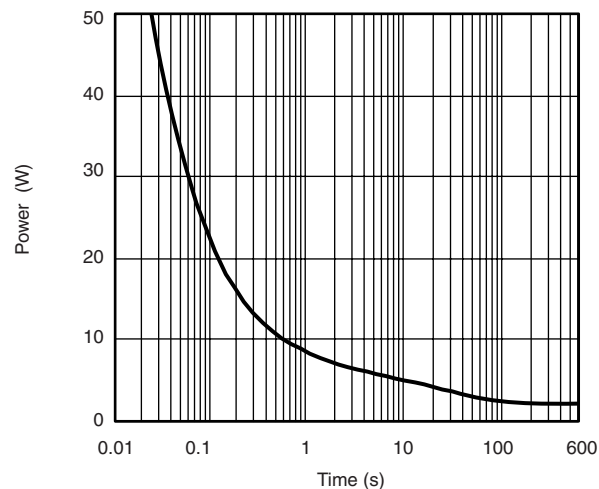
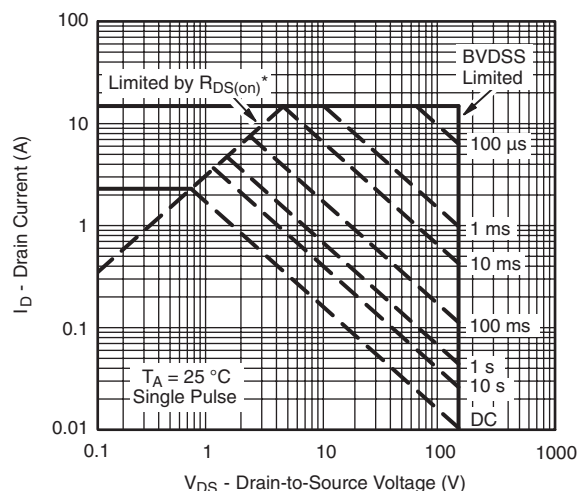
a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

b. Guaranteed by design, not subject to production testing.

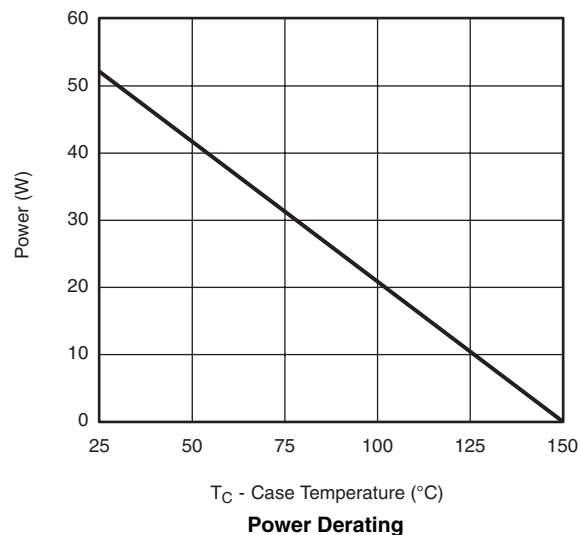
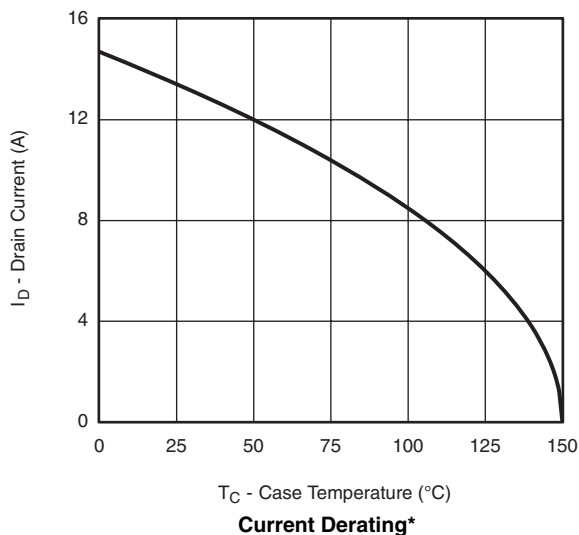
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

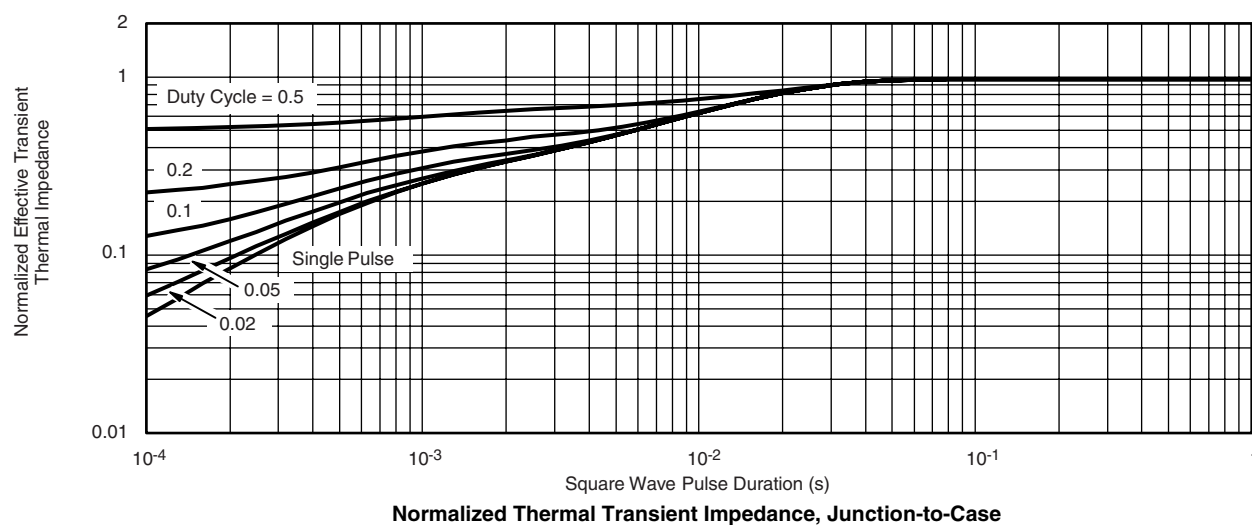
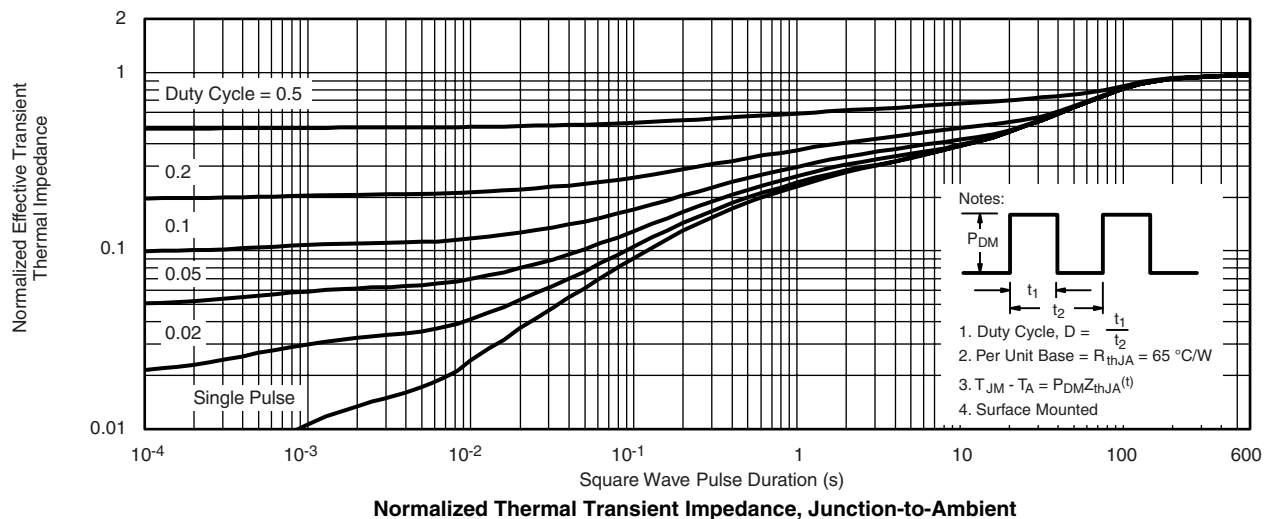


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted**Source-Drain Diode Forward Voltage****On-Resistance vs. Gate-to-Source Voltage****Threshold Voltage****Single Pulse Power (Junction-to-Ambient)*** $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified**Safe Operating Area, Junction-to-Ambient**

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150\text{ °C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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